

## NP89N04MUK, NP89N04NUK

#### MOS FIELD EFFECT TRANSISTOR

R07DS0599EJ0200 Rev.2.00 May 24, 2018

#### **Description**

These products are N-channel MOS Field Effect Transistors designed for high current switching applications.

#### **Features**

- Super low on-state resistance  $R_{DS(on)} = 3.3 \text{ m}\Omega \text{ MAX.} (V_{GS} = 10 \text{ V}, I_D = 45 \text{ A})$
- Low  $C_{iss}$ :  $C_{iss} = 3900 \text{ pF TYP.} (V_{DS} = 25 \text{ V})$
- Designed for automotive application and AEC-Q101 qualified

#### **Ordering Information**

Part No.	Lead Plating	Packing	Package
NP89N04MUK-S18-AY *1	Pure Sn (Tin)	Tube 50 p/tube	TO-220 (MP-25K)
NP89N04NUK-S18-AY *1			TO-262 (MP-25SK)

Note: \*1 Pb-free (This product does not contain Pb in the external electrode)

#### **Absolute Maximum Ratings** $(T_A = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to Source Voltage (V <sub>GS</sub> = 0 V)	V <sub>DSS</sub>	40	V
Gate to Source Voltage (V <sub>DS</sub> = 0 V)	V <sub>GSS</sub>	±20	V
Drain Current (DC) (T <sub>C</sub> = 25°C)	I <sub>D(DC)</sub>	±90	Α
Drain Current (pulse) *1, 3	I <sub>D(pulse)</sub>	±360	Α
Total Power Dissipation (T <sub>C</sub> = 25°C)	P <sub>T1</sub>	147	W
Total Power Dissipation (T <sub>A</sub> = 25°C)	P <sub>T2</sub>	1.8	W
Channel Temperature	T <sub>ch</sub>	175	°C
Storage Temperature	T <sub>stg</sub>	-55 to 175	°C
Repetitive Avalanche Current *2, 3	I <sub>AR</sub>	37	Α
Repetitive Avalanche Energy *2, 3	E <sub>AR</sub>	136	mJ

#### **Thermal Resistance**

Notes: \*1 T<sub>C</sub> = 25°C,  $P_W \le 10~\mu s$ , Duty Cycle  $\le 1\%$ 

\*2 R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20  $\rightarrow$  0 V

\*3 Not subject of production test. Verified by design/characterization.

#### **Electrical Characteristics** (T<sub>A</sub> = 25°C)

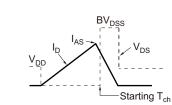
Item	Symbol	MIN.	TYP.	MAX.	Unit	Test Conditions	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$	
Gate Leakage Current	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	
Gate to Source Threshold Voltage	$V_{GS(th)}$	2.0	3.0	4.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Forward Transfer Admittance *1	<b>y</b> fs	30	60	_	S	$V_{DS} = 5 \text{ V}, I_{D} = 45 \text{ A}$	
Drain to Source On-state Resistance *1	R <sub>DS(on)</sub>	_	2.75	3.30	mΩ	$V_{GS} = 10 \text{ V}, I_D = 45 \text{ A}$	
Input Capacitance *2	C <sub>iss</sub>	_	3900	5850	pF	V <sub>DS</sub> = 25 V	
Output Capacitance *2	Coss	_	530	800	pF	$V_{GS} = 0 V$	
Reverse Transfer Capacitance *2	C <sub>rss</sub>	_	200	360	pF	f = 1 MHz	
Turn-on Delay Time *2	t <sub>d(on)</sub>	_	25	60	ns	V <sub>DD</sub> = 20 V, I <sub>D</sub> = 45 A	
Rise Time *2	t <sub>r</sub>	_	12	30	ns	V <sub>GS</sub> = 10 V	
Turn-off Delay Time *2	$t_{d(off)}$	_	65	130	ns	$R_G = 0 \Omega$	
Fall Time *2	t <sub>f</sub>	_	8	20	ns		
Total Gate Charge *2	$Q_G$	_	68	102	nC	V <sub>DD</sub> = 32 V	
Gate to Source Charge	Q <sub>GS</sub>	_	18	_	nC	V <sub>GS</sub> = 10 V	
Gate to Drain Charge	Q <sub>GD</sub>	_	18	_	nC	I <sub>D</sub> = 90 A	
Body Diode Forward Voltage *1	V <sub>F(S-D)</sub>		0.95	1.5	V	I <sub>F</sub> = 90 A, V <sub>GS</sub> = 0 V	
Reverse Recovery Time	t <sub>rr</sub>		47		ns	I <sub>F</sub> = 90 A, V <sub>GS</sub> = 0 V	
Reverse Recovery Charge	Qrr	_	68	_	nC	di/dt = 100 A/μs	

Note: \*1 Pulsed test

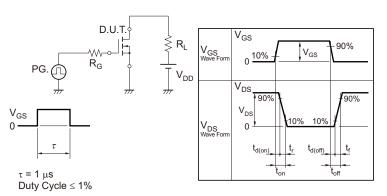
Note: \*2 Not subject of production test. Verified by design/characterization.

#### **TEST CIRCUIT 1 AVALANCHE CAPABILITY**

# $V_{GS} = 20 \rightarrow 0 \text{ V}$ $V_{GS} = 20 \rightarrow 0 \text{ V}$ $V_{DD}$



#### **TEST CIRCUIT 2 SWITCHING TIME**

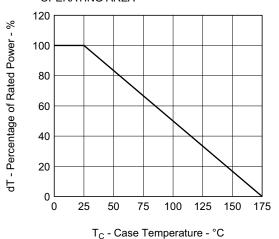


#### **TEST CIRCUIT 3 GATE CHARGE**

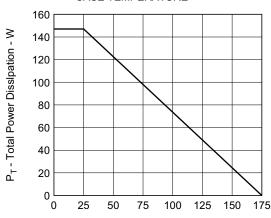
$$\begin{array}{c|c} D.U.T. \\ I_G = 2 \text{ mA} \\ \hline \end{array} \begin{array}{c} PG. \\ \hline \end{array} \begin{array}{c} S \\ S \\ \end{array} \begin{array}{c} S \\ S \\ \end{array} \begin{array}{c} O.U.T. \\ \hline \end{array} \begin{array}{c} O.U.T. \\ \end{array} \begin{array}{c} O.U.T. \\$$

#### **Typical Characteristics** $(T_A = 25^{\circ}C)$

## DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA

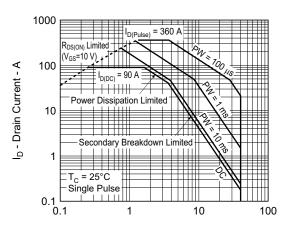


## TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



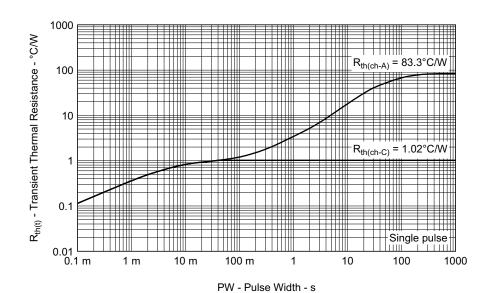
T<sub>C</sub> - Case Temperature - °C

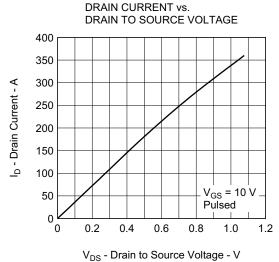
#### FORWARD BIAS SAFE OPERATING AREA

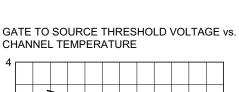


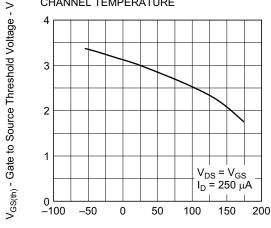
 $V_{DS}$  - Drain to Source Voltage - V

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

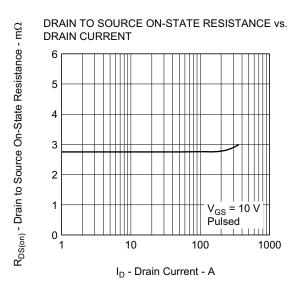




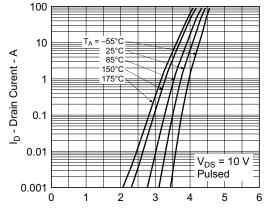




 $\rm T_{ch}$  - Channel Temperature -  $^{\circ}\rm C$ 

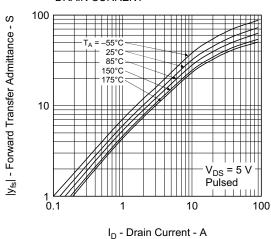


#### FORWARD TRANSFER CHARACTERISTICS

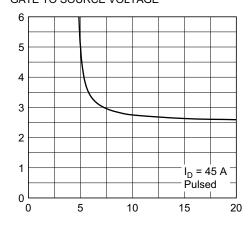


V<sub>GS</sub> - Gate to Source Voltage - V

#### FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

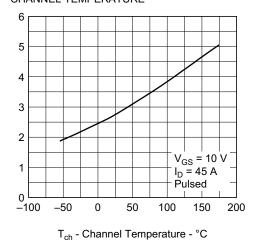


V<sub>GS</sub> - Gate to Source Voltage - V

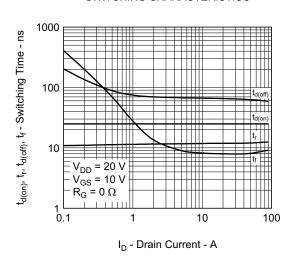
 $R_{DS(on)}$  - Drain to Source On-State Resistance -  $m\Omega$ 

 $R_{DS(on)}$  - Drain to Source On-State Resistance -  $m\Omega$ 

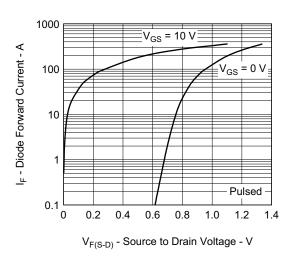
## DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



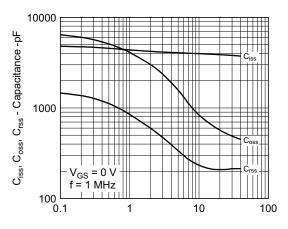
#### SWITCHING CHARACTERISTICS



#### SOURCE TO DRAIN DIODE FORWARD VOLTAGE

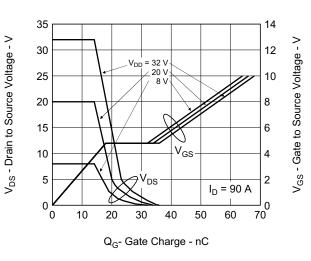


#### CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

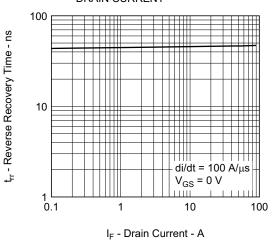


V<sub>DS</sub> - Drain to Source Voltage - V

#### DYNAMIC INPUT/OUTPUT CHARACTERISTICS

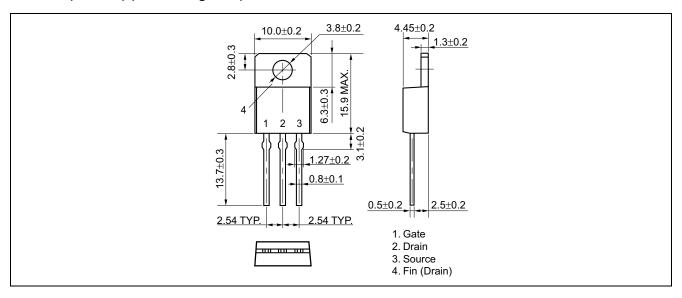


REVERSE RECOVERY TIME vs. DRAIN CURRENT

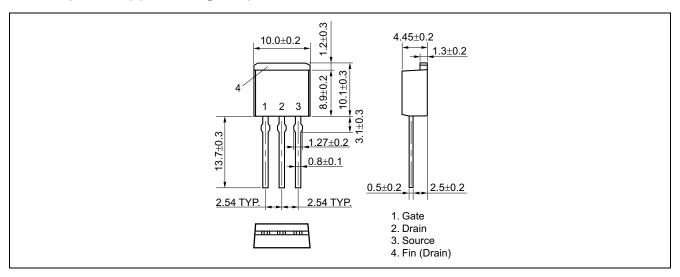


#### Package Drawing (Unit: mm)

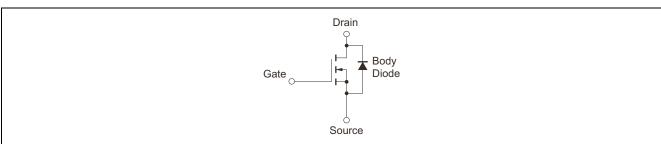
TO-220 (MP-25K) (Mass: 1.9 g TYP.)



#### TO-262 (MP-25SK) (Mass: 1.8 g TYP.)



#### **Equivalent Circuit**



Remark: Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

**Revision History** 

## NP89N04MUK, NP89N04NUK Data Sheet

		Description		
Rev.	Date	Page	Summary	
1.00	Jan 11, 2012	_	First Edition Issued	
2.00	May 24 ,2018	1	Note 3 was added	
		2	Note 2 was added	

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